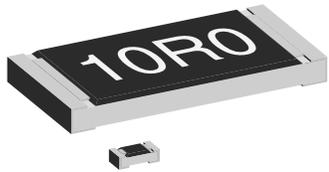


Lead (Pb)-Bearing Thick Film, Rectangular Chip Resistors



FEATURES

HALOGEN
FREE

- Stability $\Delta R/R = 1\%$ for 1000 h at 70 °C
- Lead (Pb)-bearing solder contacts on Ni barrier layer provides compatibility with lead (Pb)-free and lead containing soldering processes
- Metal glaze on high quality ceramic
- Halogen-free according to IEC 61249-2-21 definition
- AEC-Q200 qualified, rev. C compliant

STANDARD ELECTRICAL SPECIFICATIONS

MODEL	SIZE		RATED DISSIPATION P_{70} W	LIMITING ELEMENT VOLTAGE $U_{max. AC/DC}$	TEMPERATURE COEFFICIENT ppm/K	TOLERANCE %	RESISTANCE RANGE Ω	SERIES
	INCH	METRIC						
D10/CRCW0402	0402	RR 1005M	0.063	50	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24
			Zero-Ohm-Resistor: $R_{max.} = 20\text{ m}\Omega$, $I_{max.} = 1.5\text{ A}$					
D11/CRCW0603	0603	RR 1608M	0.10	75	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24
			Zero-Ohm-Resistor: $R_{max.} = 20\text{ m}\Omega$, $I_{max.} = 2.0\text{ A}$					
D12/CRCW0805	0805	RR 2012M	0.125	150	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24
			Zero-Ohm-Resistor: $R_{max.} = 20\text{ m}\Omega$, $I_{max.} = 2.5\text{ A}$					
D25/CRCW1206	1206	RR 3216M	0.25	200	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24
			Zero-Ohm-Resistor: $R_{max.} = 20\text{ m}\Omega$, $I_{max.} = 3.5\text{ A}$					
CRCW1210	1210	RR 3225M	0.50	200	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24
			Zero-Ohm-Resistor: $R_{max.} = 20\text{ m}\Omega$, $I_{max.} = 5.0\text{ A}$					
CRCW1218	1218	RR 3246M	1.0	200	± 100 ± 200	± 1 ± 5	1R0 to 2M2	E24; E96 E24
			Zero-Ohm-Resistor: $R_{max.} = 20\text{ m}\Omega$, $I_{max.} = 7.0\text{ A}$					
CRCW2010	2010	RR 5025M	0.75	400	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24
			Zero-Ohm-Resistor: $R_{max.} = 20\text{ m}\Omega$, $I_{max.} = 6.0\text{ A}$					
CRCW2512	2512	RR 6332M	1.0	500	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24
			Zero-Ohm-Resistor: $R_{max.} = 20\text{ m}\Omega$, $I_{max.} = 7.0\text{ A}$					

Notes

- These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.
- Marking: See datasheet "Surface Mount Resistor Marking" (document number 20020).
- Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.



TECHNICAL SPECIFICATIONS									
PARAMETER	UNIT	D10/ CRCW0402	D11/ CRCW0603	D12/ CRCW0805	D25/ CRCW1206	CRCW1210	CRCW1218	CRCW2010	CRCW2512
Rated dissipation at 70 °C ⁽¹⁾	W	0.063	0.1	0.125	0.25	0.5	1.0	0.75	1.0
Limiting element voltage U_{MAX} . AC/DC	V	50	75	150	200	200	200	400	500
Insulation voltage U_{INS} . (1 min)	V	> 75	> 100	> 200	> 300	> 300	> 300	> 300	> 300
Insulation resistance	Ω	> 10 ⁹							
Category temperature range	°C	- 55 to + 155							
Failure rate	h ⁻¹	< 0.1 x 10 ⁻⁹							
Weight	mg	0.65	2	5.5	10	16	29.5	25.5	40.5

Note

⁽¹⁾ The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.

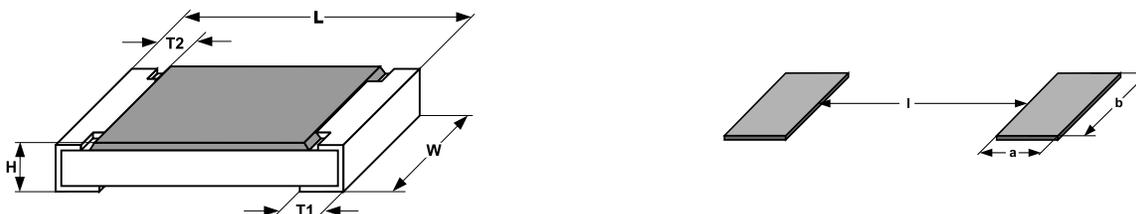
PART NUMBER AND PRODUCT DESCRIPTION																	
Part Number: CRCW0805562RFKTA ⁽²⁾																	
C	R	C	W	0	8	0	5	5	6	2	R	F	K	T	A		
MODEL		VALUE			TOLERANCE			TCR		PACKAGING			SPECIAL				
CRCW0402 CRCW0603 CRCW0805 CRCW1206 CRCW1210 CRCW1218 CRCW2010 CRCW2512		R = Decimal K = Thousand M = Million 0000 = Jumper			F = ± 1 % J = ± 5 % Z = Jumper			K = ± 100 ppm/K N = ± 200 ppm/K S = Jumper or special		TA TB TC TD TE TF TG TH TK			Up to 2 digits				
Product Description: CRCW0805 100 562R 1 % RT1																	
CRCW0805		100			562R			1 %		RT1							
MODEL		TCR			RESISTANCE VALUE			TOLERANCE		PACKAGING							
CRCW0402 CRCW0603 CRCW0805 CRCW1206 CRCW1210 CRCW1218 CRCW2010 CRCW2512		± 100 ppm/K ± 200 ppm/K			10R = 10 Ω 562R = 562 Ω 10K = 10.0 k Ω 1M = 1 M Ω 0R0 = Jumper			± 1 % ± 5 %		RT1 RT5 RT6 RT7 RT4 R02 R67 R82 RT9							

Note

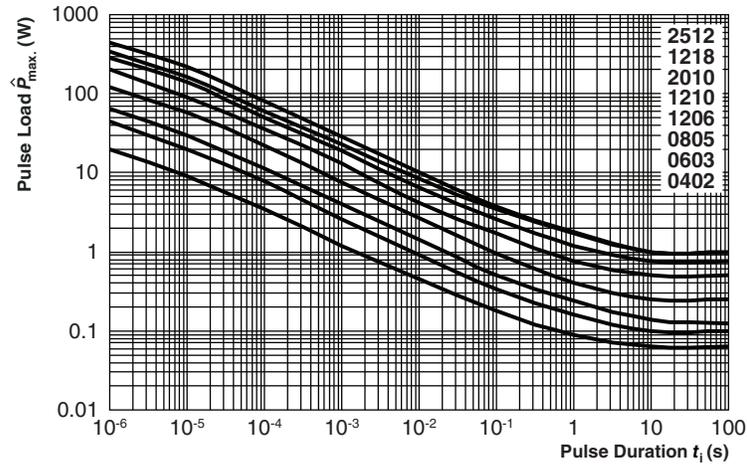
⁽²⁾ Preferred way for ordering products is by use of the PART NUMBER.

PACKAGING							
MODEL	UNIT	PAPER TAPE ACC. IEC 60286-3, TYPE I			BLISTER TAPE ACC. IEC 60286-3, TYPE II		
		QUANTITY	PART NUMBER	PRODUCT DESC.	QUANTITY	PART NUMBER	PRODUCT DESC.
D10/CRCW0402	180 mm/7"	10 000	TD	RT7			
	330 mm/13"	50 000	TE	RF4			
D11/CRCW0603	180 mm/7"	5000	TA	RT1			
	285 mm/11.25"	10 000	TB	RT5			
	330 mm/13"	20 000	TC	RT6			
D12/CRCW0805	180 mm/7"	5000	TA	RT1			
	285 mm/11.25"	10 000	TB	RT5			
	330 mm/13"	20 000	TC	RT6			
D25/CRCW1206	180 mm/7"	5000	TA	RT1			
	285 mm/11.25"	10 000	TB	RT5			
	330 mm/13"	20 000	TC	RT6			
CRCW1210	180 mm/7"	5000	TA	RT1			
	285 mm/11.25"	10 000	TB	RT5			
	330 mm/13"	20 000	TC	RT6			
CRCW1218	180 mm/7"				4000	TK	RT9
CRCW2010	180 mm/7"				4000	TF	R02
CRCW2512	180 mm/7"				2000	TG	R67
					4000	TH	R82

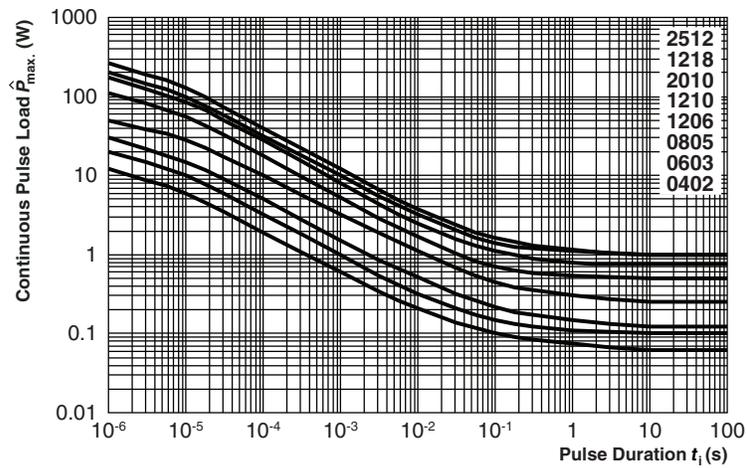
DIMENSIONS



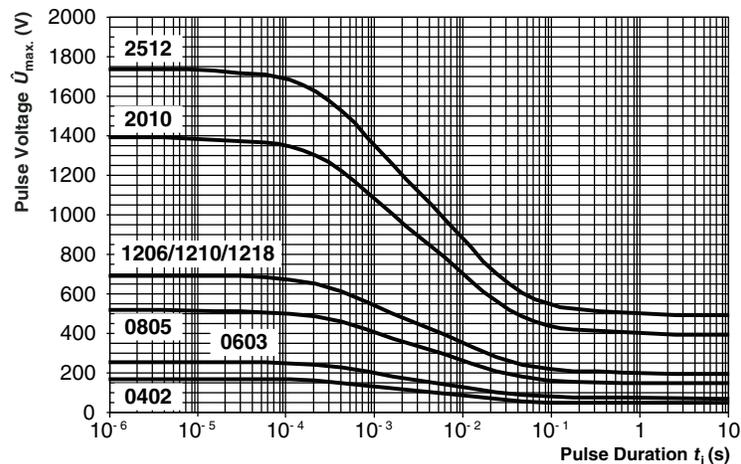
SIZE		DIMENSIONS in millimeters					SOLDER PAD DIMENSIONS in millimeters					
							REFLOW SOLDERING			WAVE SOLDERING		
INCH	METRIC	L	W	H	T1	T2	a	b	l	a	b	l
0402	1005	1.0 ± 0.05	0.5 ± 0.05	0.35 ± 0.05	0.25 ± 0.05	0.2 ± 0.1	0.4	0.6	0.5			
0603	1608	1.55 ^{+0.10} / _{-0.05}	0.85 ± 0.1	0.45 ± 0.05	0.3 ± 0.2	0.3 ± 0.2	0.5	0.9	1.0	0.9	0.9	1.0
0805	2012	2.0 ^{+0.20} / _{-0.10}	1.25 ± 0.15	0.45 ± 0.05	0.3 ^{+0.20} / _{-0.10}	0.3 ± 0.2	0.7	1.3	1.2	0.9	1.3	1.3
1206	3216	3.2 ^{+0.10} / _{-0.20}	1.6 ± 0.15	0.55 ± 0.05	0.45 ± 0.2	0.4 ± 0.2	0.9	1.7	2.0	1.1	1.7	2.3
1210	3225	3.2 ± 0.2	2.5 ± 0.2	0.55 ± 0.05	0.45 ± 0.2	0.4 ± 0.2	0.9	2.5	2.0	1.1	2.5	2.2
1218	3246	3.2 ^{+0.10} / _{-0.20}	4.6 ± 0.15	0.55 ± 0.05	0.45 ± 0.2	0.4 ± 0.2	1.05	4.9	1.9	1.25	4.8	1.9
2010	5025	5.0 ± 0.15	2.5 ± 0.15	0.6 ± 0.1	0.6 ± 0.2	0.6 ± 0.2	1.0	2.5	3.9	1.2	2.5	3.9
2512	6332	6.3 ± 0.2	3.15 ± 0.15	0.6 ± 0.1	0.6 ± 0.2	0.6 ± 0.2	1.0	3.2	5.2	1.2	3.2	5.2

FUNCTIONAL PERFORMANCE
Single Pulse


Maximum pulse load, single pulse; applicable if $\bar{P} \rightarrow 0$ and $n < 1000$ and $\bar{U} \leq \bar{U}_{max}$; for permissible resistance change equivalent to 8000 h operation

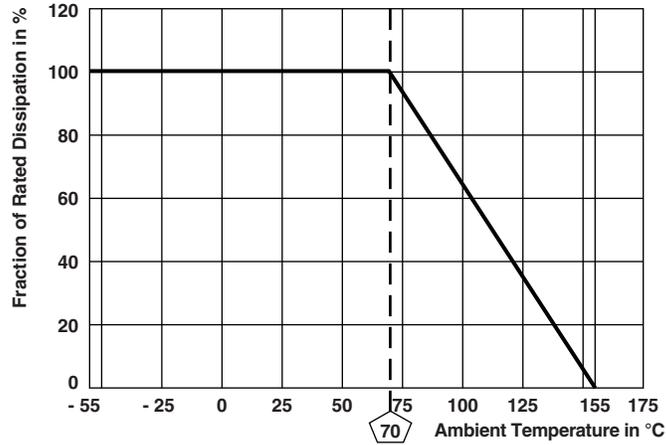
Continuous Pulse


Maximum pulse load, continuous pulses; applicable if $\bar{P} \leq P(\theta_{amb})$ and $\bar{U} \leq \bar{U}_{max}$; for permissible resistance change equivalent to 8000 h operation

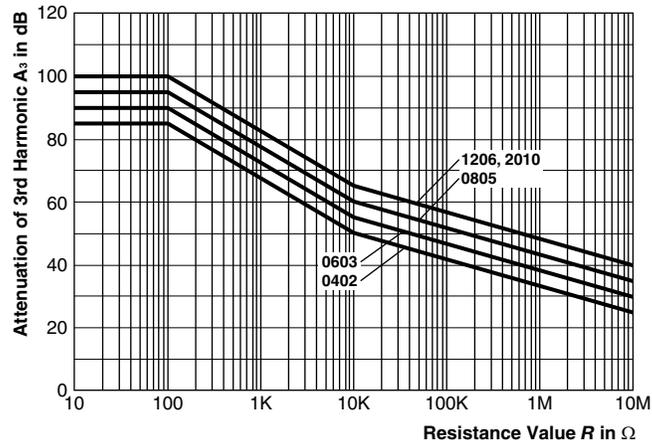
Pulse Voltage


Maximum pulse voltage, single and continuous pulses; applicable if $\hat{P} \leq \hat{P}_{max}$; for permissible resistance change equivalent to 8000 h operation

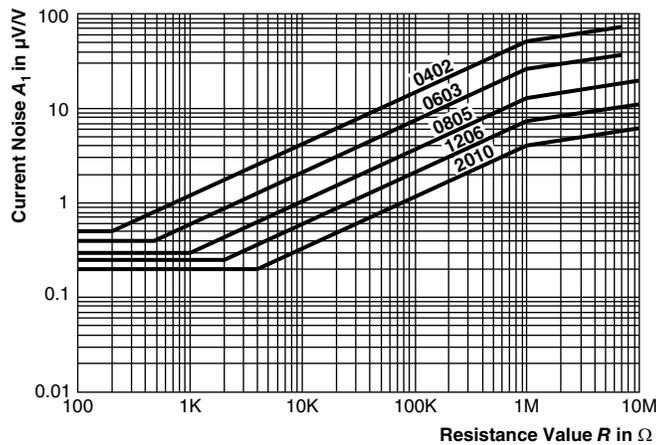
Derating



Non-Linearity



Current Noise





TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60082-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
				STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER
				Stability for product types:	1 Ω to 10 M Ω
			D/CRCW		
4.5	-	Resistance	-	$\pm 1\%$	$\pm 5\%$
4.7	-	Voltage proof	$U = 1.4 \cdot U_{ins}$; 60 s	No flashover or breakdown	
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R} \leq 2 \times U_{max.}$; duration: Acc. to style	$\pm (0.25\% R + 0.05 \Omega)$	$\pm (0.5\% R + 0.05 \Omega)$
4.17.2	58 (Td)	Solderability	Solder bath method; Sn60Pb40; non-activated flux; (235 \pm 5) $^{\circ}$ C, (2 \pm 0.2) s Solder bath method; Sn96.5Ag3Cu0.5; non-activated flux; (245 \pm 5) $^{\circ}$ C, (3 \pm 0.3) s	Good tinning ($\geq 95\%$ covered); no visible damage	
4.8.4.2	-	Temperature coefficient	(20/- 55/20) $^{\circ}$ C and (20/125/20) $^{\circ}$ C	± 100 ppm/K	± 200 ppm/K
4.32	21 (Uu ₃)	Shear (adhesion)	RR 1608 and smaller: 9 N RR 2012 and larger: 45 N	No visible damage	
4.33	21 (Uu ₁)	Substrate bending	Depth 2 mm; 3 times	No visible damage, no open circuit in bent position $\pm (0.25\% R + 0.05 \Omega)$	
4.19	14 (Na)	Rapid change of temperature	30 min. at - 55 $^{\circ}$ C; 30 min. at 125 $^{\circ}$ C 5 cycles 1000 cycles	$\pm (0.25\% R + 0.05 \Omega)$ $\pm (1\% R + 0.05 \Omega)$	$\pm (0.5\% R + 0.05 \Omega)$ $\pm (1\% R + 0.05 \Omega)$
4.23	-	Climatic sequence:	-		
4.23.2	2 (Ba)	Dry heat	125 $^{\circ}$ C; 16 h		
4.23.3	30 (Db)	Damp heat, cyclic	55 $^{\circ}$ C; $\geq 90\%$ RH; 24 h; 1 cycle		
4.23.4	1 (Aa)	Cold	- 55 $^{\circ}$ C; 2 h	$\pm (1\% R + 0.05 \Omega)$	$\pm (2\% R + 0.1 \Omega)$
4.23.5	13 (M)	Low air pressure	1 kPa; (25 \pm 10) $^{\circ}$ C; 1 h		
4.23.6	30 (Db)	Damp heat, cyclic	55 $^{\circ}$ C; $\geq 90\%$ RH; 24 h; 5 cycles		
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R}$		
4.25.1	-	Endurance at 70 $^{\circ}$ C	$U = \sqrt{(P_{70} \times R)} \leq U_{max.}$ 1.5 h on; 0.5 h off; 70 $^{\circ}$ C; 1000 h 70 $^{\circ}$ C; 8000 h	$\pm (1\% R + 0.05 \Omega)$ $\pm (2\% R + 0.1 \Omega)$	$\pm (2\% R + 0.1 \Omega)$ $\pm (4\% R + 0.1 \Omega)$
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method (260 \pm 5) $^{\circ}$ C; (10 \pm 1) s	$\pm (0.25\% R + 0.05 \Omega)$	$\pm (0.5\% R + 0.05 \Omega)$
4.35	-	Flamability, needle flame test	IEC 60695-11-5; 10 s	No burning after 30 s	
4.24	78 (Cab)	Damp heat, steady state	(40 \pm 2) $^{\circ}$ C; (93 \pm 3) % RH; 56 days	$\pm (1\% R + 0.05 \Omega)$	
4.25.3	-	Endurance at upper category temperature	155 $^{\circ}$ C; 1000 h	$\pm (1\% R + 0.05 \Omega)$	$\pm (2\% R + 0.1 \Omega)$
4.40	-	Electrostatic discharge (human body model)	IEC 61340-3-1 3 pos. + 3 neg. discharges; ESD test voltage acc. to size	$\pm (1\% R + 0.05 \Omega)$	

TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60082-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
				STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER
				Stability for product types:	1 Ω to 10 M Ω
			D/CRCW		
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible damage	
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1, toothbrush	Marking legible, no visible damage	
4.22	6 (Fc)	Vibration, endurance by sweeping	f = 10 Hz to 2000 Hz; x, y, z \leq 1.5 mm; A \leq 200 m/s ² ; 10 sweeps per axis	\pm (0.25 % R + 0.05 Ω)	\pm (0.5 % R + 0.05 Ω)
4.37	-	Periodic electric overload	$U = \sqrt{15 \times P_{70} \times R} \leq 2 \times U_{max.}$; 0.1 s on; 2.5 s off; 1000 cycles	\pm (1 % R + 0.05 Ω)	
4.27	-	Single pulse high voltage overload, 10 μ s/700 μ s	$\dot{U} = 10 \times \sqrt{P_{70} \times R} \leq 2 \times U_{max.}$; 10 pulses	\pm (1 % R + 0,05 Ω)	

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2, environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3.



Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.